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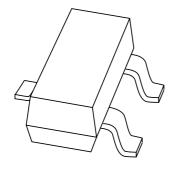
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Kind regards,

Team Nexperia

DISCRETE SEMICONDUCTORS

DATA SHEET



MMBT3906 PNP switching transistor

Product data sheet Supersedes data of 2000 Apr 11 2003 Mar 18



PNP switching transistor

MMBT3906

FEATURES

- Collector current capability I_C = −200 mA
- Collector-emitter voltage $V_{CEO} = -40 \text{ V}$.

APPLICATIONS

· General switching and amplification.

DESCRIPTION

PNP switching transistor in a SOT23 plastic package. NPN complement: MMBT3904.

MARKING

| TYPE NUMBER | MARKING CODE(1) |
|-------------|-----------------|
| MMBT3906 | 7B* |

Note

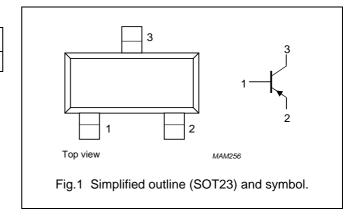
- 1. * = p: Made in Hong Kong.
 - * = t: Made in Malaysia.
 - * = W: Made in China.

QUICK REFERENCE DATA

| SYMBOL | PARAMETER | MAX. | UNIT |
|------------------|---------------------------|------|------|
| V _{CEO} | collector-emitter voltage | -40 | V |
| I _C | collector current (DC) | -200 | mA |

PINNING

| PIN | DESCRIPTION |
|-----|-------------|
| 1 | base |
| 2 | emitter |
| 3 | collector |



LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|------------------|-------------------------------|----------------------------------|------|------|------|
| V _{CBO} | collector-base voltage | open emitter | _ | -40 | V |
| V_{CEO} | collector-emitter voltage | open base | _ | -40 | V |
| V _{EBO} | emitter-base voltage | open collector | _ | -6 | V |
| I _C | collector current (DC) | | _ | -200 | mA |
| I _{CM} | peak collector current | | _ | -200 | mA |
| I _{BM} | peak base current | | _ | -100 | mA |
| P _{tot} | total power dissipation | T _{amb} ≤ 25 °C; note 1 | _ | 250 | mW |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| Tj | junction temperature | | _ | 150 | °C |
| T _{amb} | operating ambient temperature | | -65 | +150 | °C |

Note

1. Transistor mounted on an FR4 printed-circuit board.

PNP switching transistor

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THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | CONDITIONS | VALUE | UNIT |
|---------------------|---|------------|-------|------|
| R _{th j-a} | thermal resistance from junction to ambient | note 1 | 500 | K/W |

Note

1. Transistor mounted on an FR4 printed-circuit board.

CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|--------------------|---------------------------------|---|------|------|------|
| I _{CBO} | collector cut-off current | I _E = 0; V _{CB} = -30 V | _ | -50 | nA |
| I _{EBO} | emitter cut-off current | $I_C = 0; V_{EB} = -6 \text{ V}$ | _ | -50 | nA |
| h _{FE} | DC current gain | V _{CE} = −1 V; see Fig.2 | | | |
| | | $I_{\rm C} = -0.1 \text{mA}$ | 60 | _ | |
| | | $I_C = -1 \text{ mA}$ | 80 | _ | |
| | | $I_{\rm C} = -10 \; {\rm mA}$ | 100 | 300 | |
| | | $I_{\rm C} = -50 \; {\rm mA}$ | 60 | _ | |
| | | $I_{\rm C} = -100 \text{ mA}$ | 30 | _ | |
| V _{CEsat} | collector-emitter saturation | $I_C = -10 \text{ mA}; I_B = -1 \text{ mA}$ | _ | -250 | mV |
| | voltage | $I_C = -50 \text{ mA}; I_B = -5 \text{ mA}$ | _ | -400 | mV |
| V _{BEsat} | base-emitter saturation voltage | $I_C = -10 \text{ mA}; I_B = -1 \text{ mA}$ | _ | -850 | mV |
| | | $I_C = -50 \text{ mA}; I_B = -5 \text{ mA}$ | _ | -950 | mV |
| C _c | collector capacitance | $I_E = i_e = 0$; $V_{CB} = -5 \text{ V}$; $f = 1 \text{ MHz}$ | _ | 4.5 | pF |
| C _e | emitter capacitance | $I_C = I_c = 0$; $V_{EB} = -500 \text{ mV}$; $f = 1 \text{ MHz}$ | _ | 10 | pF |
| f _T | transition frequency | $I_C = -10 \text{ mA}; V_{CE} = -20 \text{ V};$ f = 100 MHz | 250 | _ | MHz |
| F | noise figure | $I_C = -100 \mu A$; $V_{CE} = -5 V$; $R_S = 1 kΩ$; $f = 10 Hz$ to 15.7 kHz | - | 4 | dB |
| Switching ti | mes (between 10% and 90% lev | els); see Fig.7 | • | | |
| t _d | delay time | I _{Con} = -10 mA; I _{Bon} = -1 mA; | _ | 35 | ns |
| t _r | rise time | I _{Boff} = 1 mA | _ | 35 | ns |
| t _s | storage time | | _ | 225 | ns |
| t _f | fall time | | _ | 75 | ns |

PNP switching transistor

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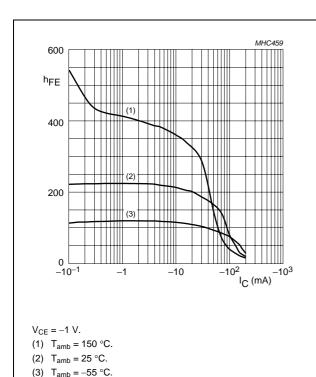
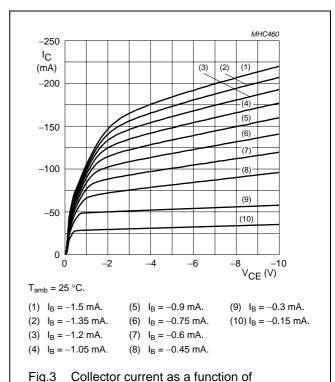
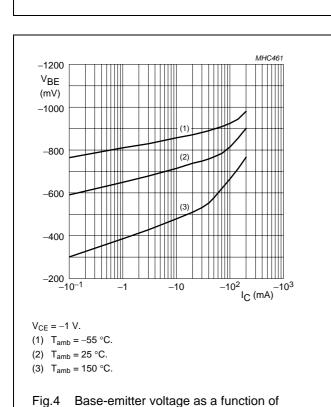
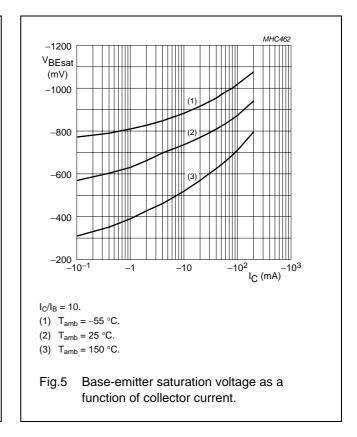


Fig.2 DC current gain; typical values.



collector-emitter voltage.





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collector current.

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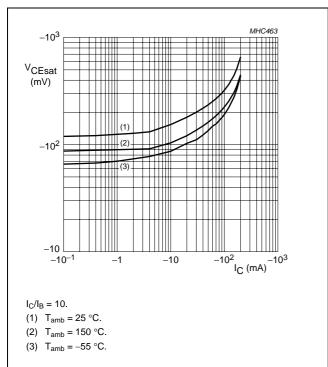
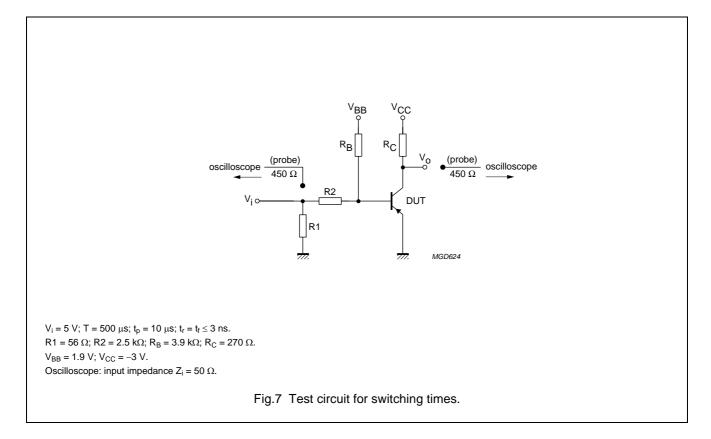


Fig.6 Collector-emitter saturation voltage as a function of collector current.



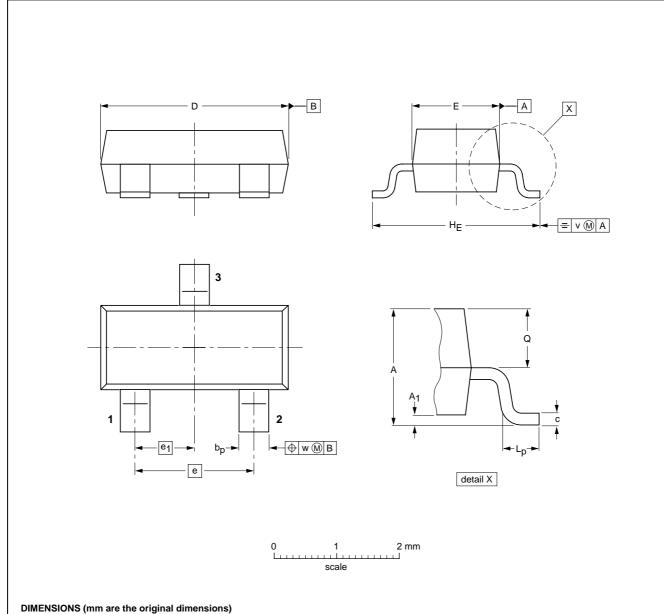
PNP switching transistor

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PACKAGE OUTLINE

Plastic surface mounted package; 3 leads

SOT23



| DIMENS | IONS (II | ım are tı | ne origir | iai dime | nsions) | |
|--------|----------|-----------|-----------|----------|---------|---|
| | | | | | | _ |

| UNIT | A | A ₁ max. | bp | С | D | E | е | e ₁ | HE | Lp | Q | ٧ | w |
|------|------------|------------------------|--------------|--------------|------------|------------|-----|----------------|------------|--------------|--------------|-----|-----|
| mm | 1.1 0.9 | 0.1 | 0.48 0.38 | 0.15 0.09 | 3.0 2.8 | 1.4 1.2 | 1.9 | 0.95 | 2.5 2.1 | 0.45 0.15 | 0.55 0.45 | 0.2 | 0.1 |

| OUTLINE | | REFER | EUROPEAN | ISSUE DATE | | |
|---------|-----|----------|----------|------------|------------|----------------------------------|
| VERSION | IEC | JEDEC | EIAJ | | PROJECTION | 1330E DATE |
| SOT23 | | TO-236AB | | | | -97-02-28 99-09-13 |

PNP switching transistor

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DATA SHEET STATUS

| DOCUMENT STATUS ⁽¹⁾ | PRODUCT STATUS ⁽²⁾ | DEFINITION |
|-----------------------------------|----------------------------------|---|
| Objective data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary data sheet | Qualification | This document contains data from the preliminary specification. |
| Product data sheet | Production | This document contains the product specification. |

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NXP Semiconductors

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